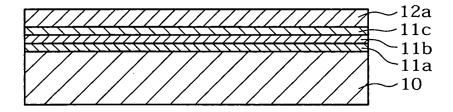
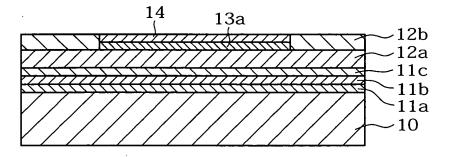
# MANUFACTURING PROCESS FOR ULTRA SLIM ELECTROOPTIC DISPLAY DEVICE UNIT Inventor: Yamanaka Hideo Docket No. 075834.00466

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F I G. 1



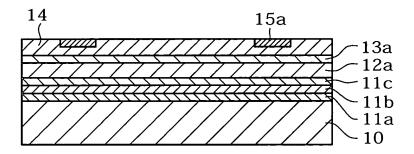
F I G. 2



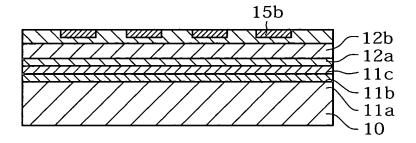
Inventor: Yamanaka Hideo Docket No. 075834.00466 Robert J. Depke, Holland & Knight LLC - (312) 263-3600

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# F I G. 3 A



# F I G. 3 B

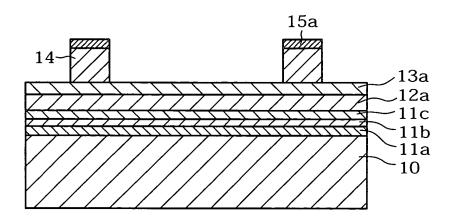


Inventor: Yamanaka Hideo Docket No. 075834.00466

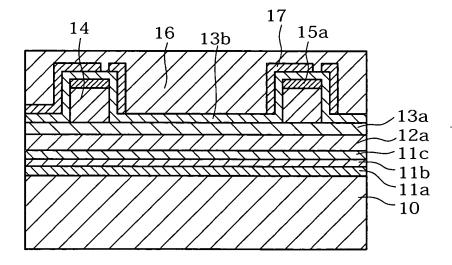
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F I G. 4



F I G. 5

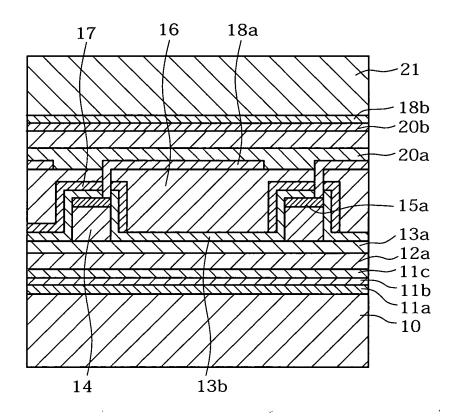


## MANUFACTURING PROCESS FOR ULTRA SLIM ELECTROOPTIC DISPLAY DEVICE UNIT Inventor: Yamanaka Hideo

Docket No. 075834.00466

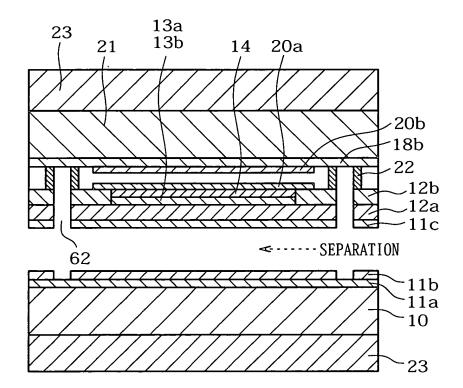
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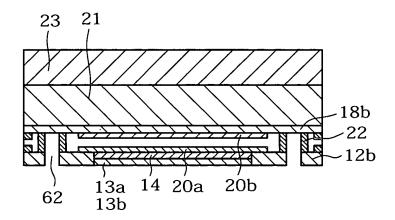
Inventor: Yamanaka Hideo Docket No. 075834.00466 Robert J. Depke, Holland & Knight LLC - (312) 263-3600

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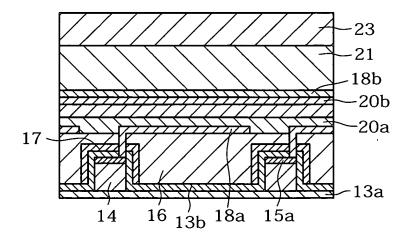


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# F I G. 8 A



F I G. 8 B

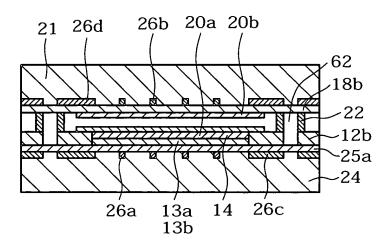


Inventor: Yamanaka Hideo Docket No. 075834.00466

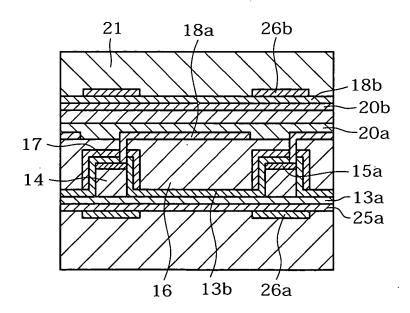
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# F I G. 9 A



# F I G. 9 B



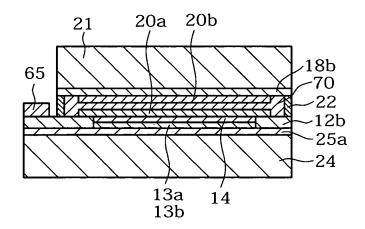
# MANUFACTURING PROCESS FOR ULTRA SLIM ELECTROOPTIC DISPLAY DEVICE UNIT Inventor: Yamanaka Hideo Docket No. 075834.00466

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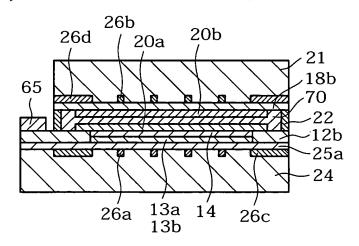
# F I G. 1 0 A

### (a) WITHOUT A LIGHT-SHIELDING FILM



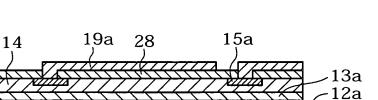
## F I G. 10B

### (a) WITH A LIGHT-SHIELDING FILM



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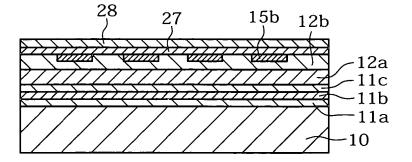
F I G. 1 1 A





-11c -11b -11a ·10

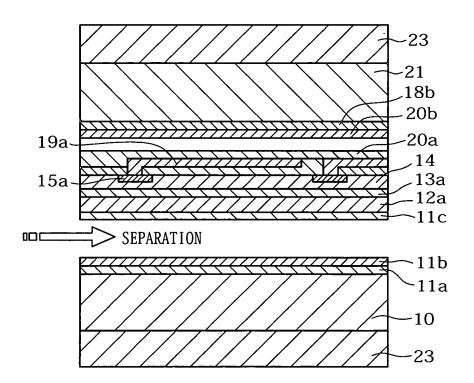
# F I G. 1 1 B



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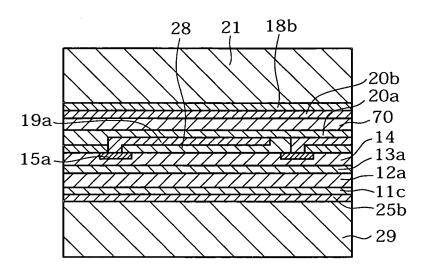
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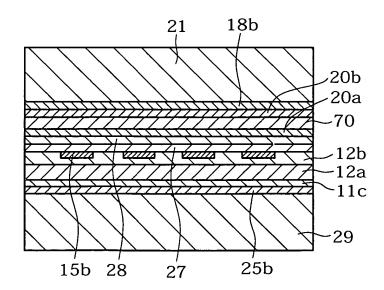
Inventor: Yamanaka Hideo Docket No. 075834.00466 Robert J. Depke, Holland & Knight LLC - (312) 263-3600

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# F I G. 13A

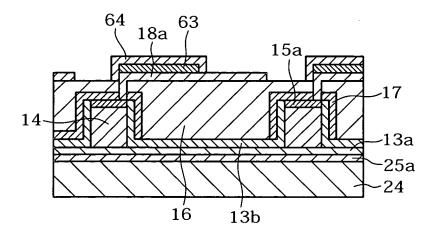


F I G. 1 3 B

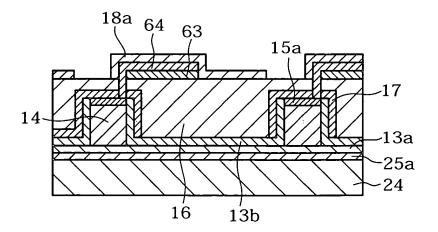


Inventor: Yamanaka Hideo Docket No. 075834.00466 
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# F I G. 1 4 A



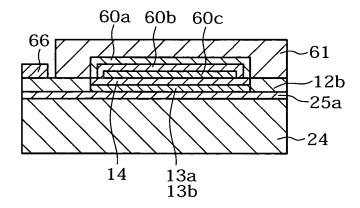
F I G. 1 4 B

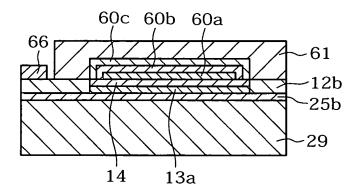


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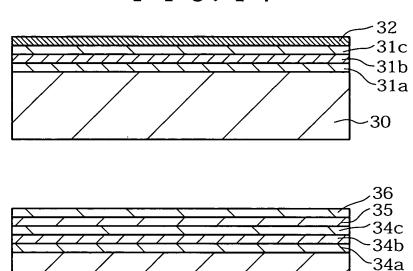
# F I G. 15





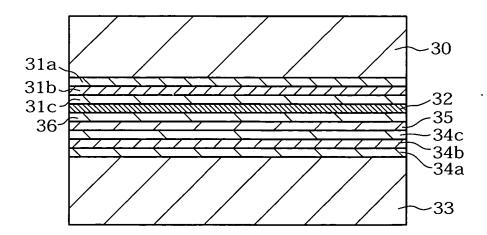
Inventor: Yamanaka Hideo Docket No. 075834.00466 Robert J. Depke, Holland & Knight LLC - (312) 263-3600  $1\ 4\ /\ 4\ 7$ 

F I G. 17



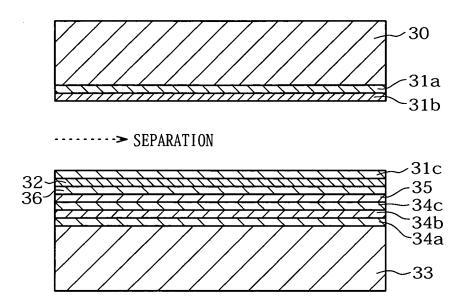
F I G. 18

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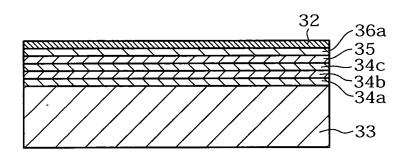


Inventor: Yamanaka Hideo Docket No. 075834.00466

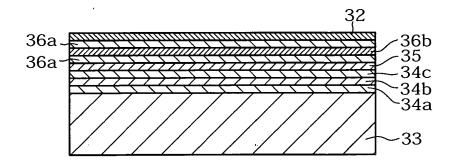
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# F I G. 20 A

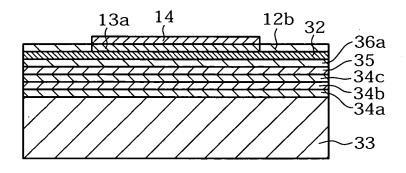


# F I G. 20B

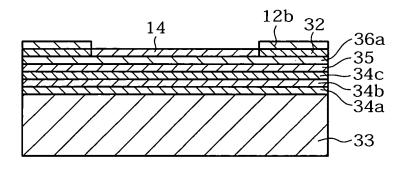


Inventor: Yamanaka Hideo Docket No. 075834.00466 
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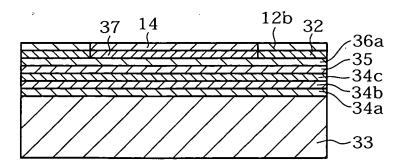
F I G. 2 1 A



F I G. 2 1 B



F I G. 2 1 C

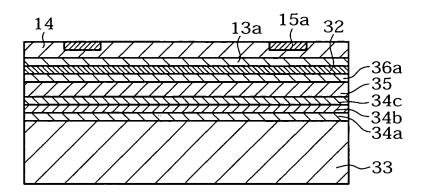


# MANUFACTURING PROCESS FOR ULTRA SLIM ELECTROOPTIC DISPLAY DEVICE UNIT Inventor: Yamanaka Hideo Docket No. 075834.00466

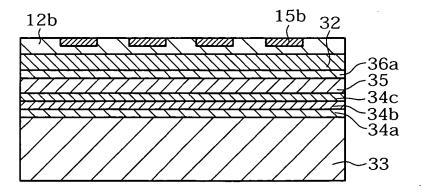
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# F I G. 22A



F I G. 22B

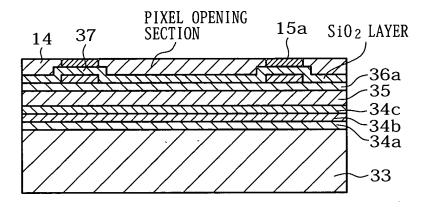


# MANUFACTURING PROCESS FOR ULTRA SLIM ELECTROOPTIC DISPLAY DEVICE UNIT Inventor: Yamanaka Hideo Docket No. 075834.00466

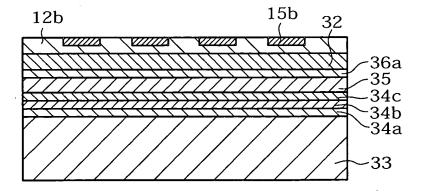
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# F I G. 23A

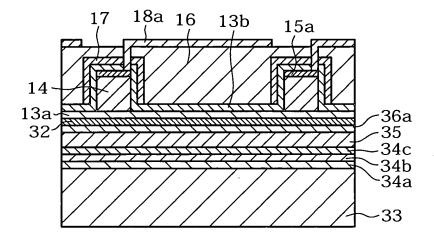


# F I G. 23B

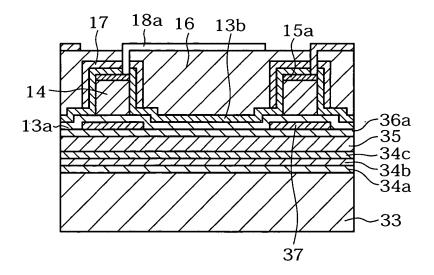


Inventor: Yamanaka Hideo Docket No. 075834.00466 
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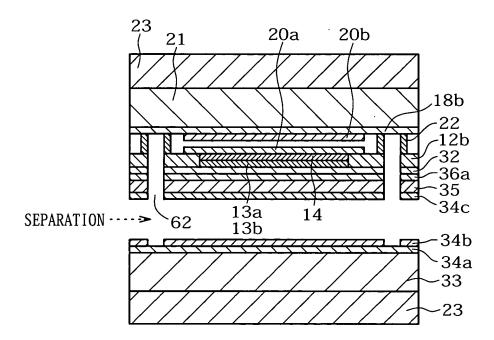
## F I G. 24A



# F I G. 24B

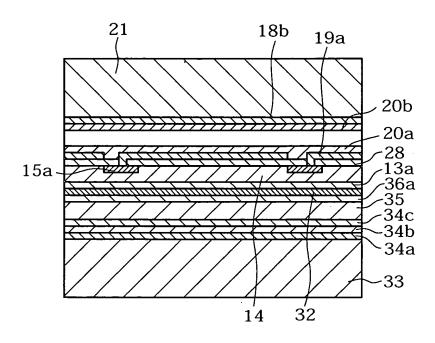


# MANUFACTURING PROCESS FOR ULTRA SLIM ELECTROOPTIC DISPLAY DEVICE UNIT Inventor: Yamanaka Hideo Docket No. 075834.00466 Robert J. Depke, Holland & Knight LLC - (312) 263-3600 $2\,1\,/\,4\,7$

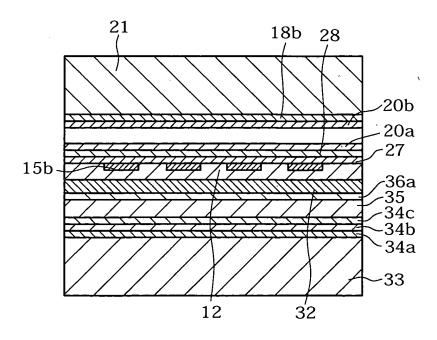


Inventor: Yamanaka Hideo Docket No. 075834.00466 
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# F I G. 26A



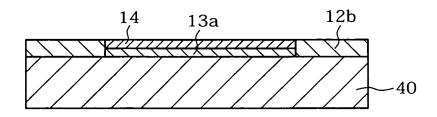
F I G. 26B



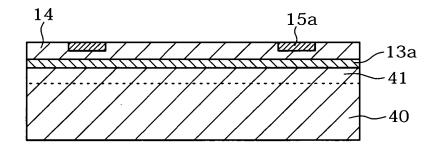
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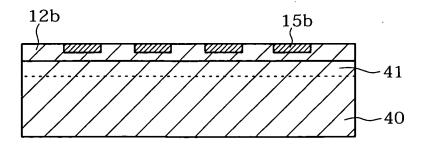
F I G. 27



F I G. 28A

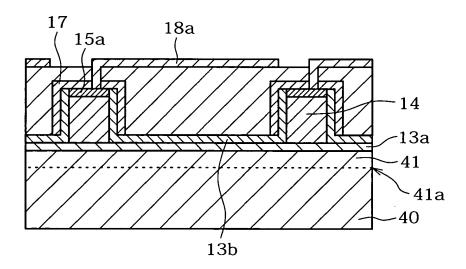


F I G. 28B

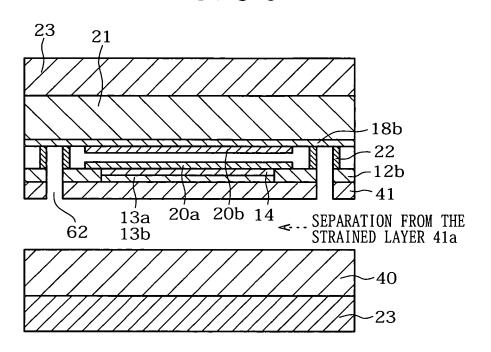


# MANUFACTURING PROCESS FOR ULTRA SLIM ELECTROOPTIC DISPLAY DEVICE UNIT Inventor: Yamanaka Hideo Docket No. 075834.00466 Robert J. Depke, Holland & Knight LLC - (312) 263-3600

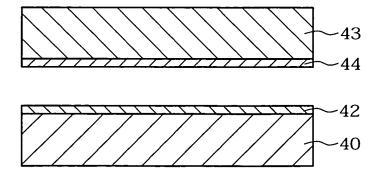
24/47



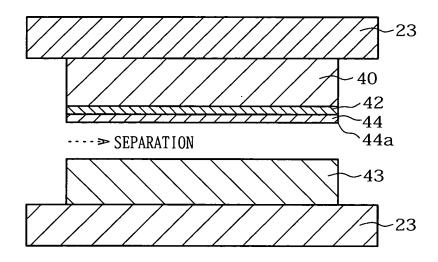
Inventor: Yamanaka Hideo Docket No. 075834.00466 Robert J. Depke, Holland & Knight LLC - (312) 263-3600  $2\,5\,/\,4\,7$ 



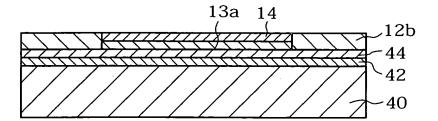
F I G. 3 1



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F I G. 33

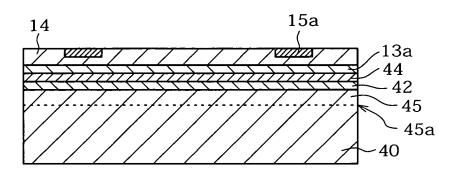


Inventor: Yamanaka Hideo Docket No. 075834.00466

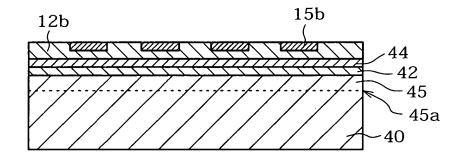
Robert J. Depke, Holland & Knight LLC - (312) 263-3600

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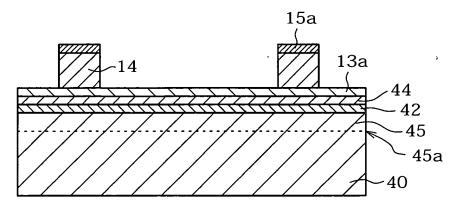
# F I G. 3 4 A



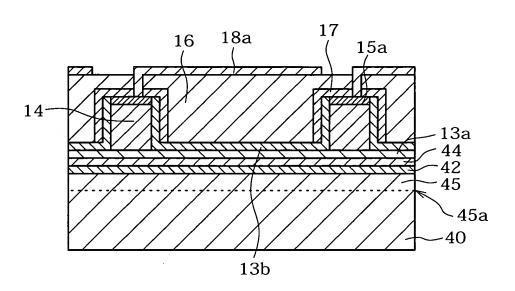
F I G. 3 4 B



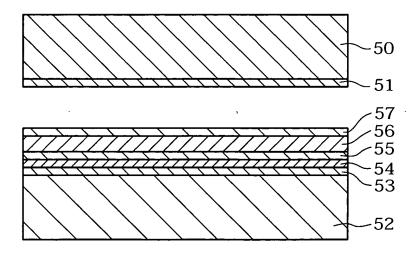
F I G. 35



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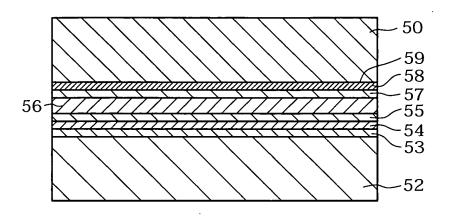


F I G. 37

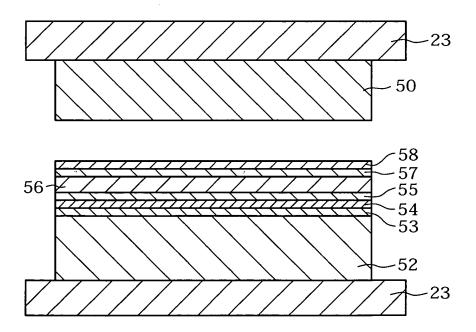


Inventor: Yamanaka Hideo Docket No. 075834.00466 Robert J. Depke, Holland & Knight LLC - (312) 263-3600  $2\,9\,/\,4\,7$ 

F I G. 38

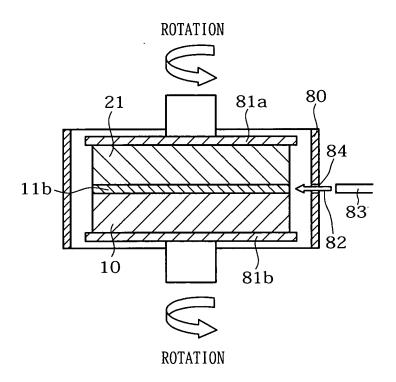


F I G. 39



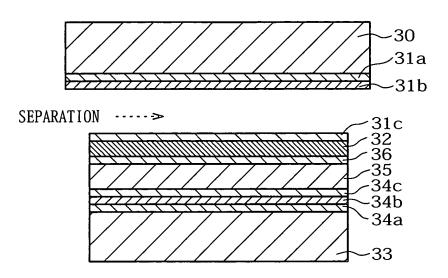
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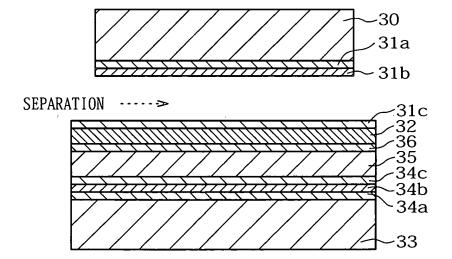


Inventor: Yamanaka Hideo Docket No. 075834.00466 
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F I G. 4 1 A

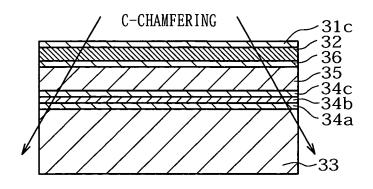


F I G. 4 1 B

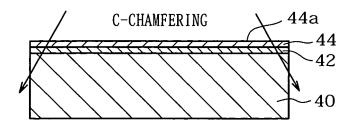


Inventor: Yamanaka Hideo Docket No. 075834.00466 Robert J. Depke, Holland & Knight LLC - (312) 263-3600  $3\,2\,/\,4\,7$ 

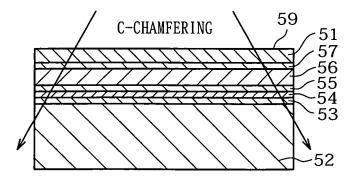
F I G. 42A



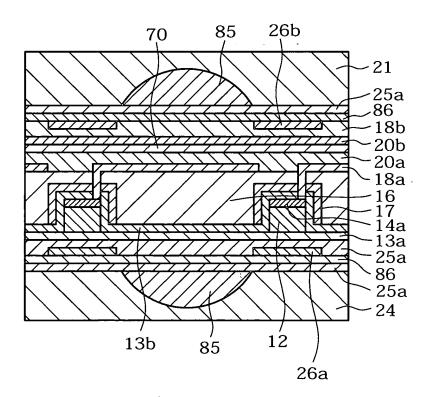
F I G. 42B



F I G. 4 2 C



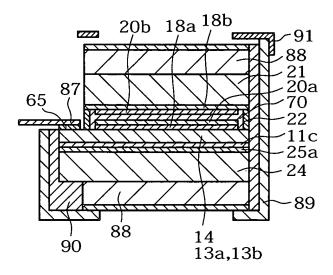
Inventor: Yamanaka Hideo Docket No. 075834.00466 Robert J. Depke, Holland & Knight LLC - (312) 263-3600  $3\,3\,/\,4\,7$ 



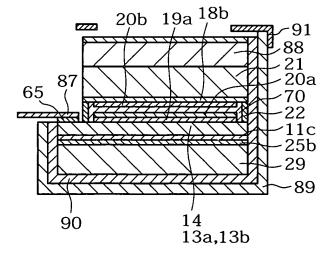
Inventor: Yamanaka Hideo Docket No. 075834.00466 Robert J. Depke, Holland & Knight LLC - (312) 263-3600

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# F I G. 4 4 A

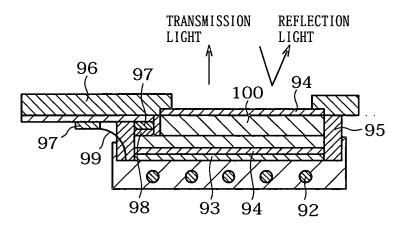


# F I G. 4 4 B

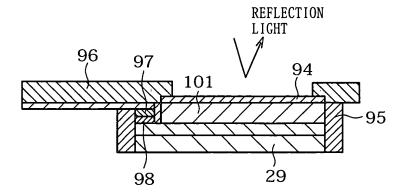


Inventor: Yamanaka Hideo Docket No. 075834.00466 
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# F I G. 4 5 A

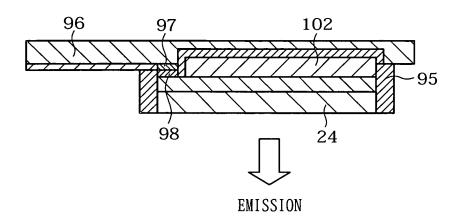


# F I G. 45B

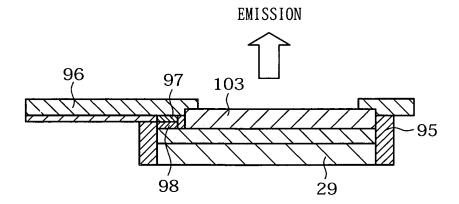


Inventor: Yamanaka Hideo Docket No. 075834.00466 Robert J. Depke, Holland & Knight LLC - (312) 263-3600  $36 \, / \, 47$ 

# F I G. 46A



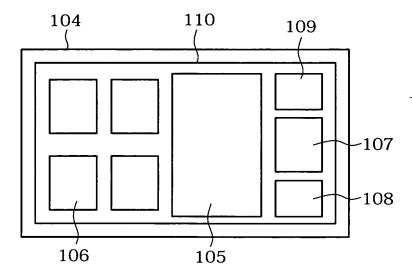
# F I G. 46B

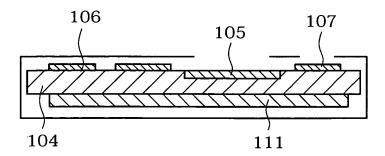


# MANUFACTURING PROCESS FOR ULTRA SLIM ELECTROOPTIC DISPLAY DEVICE UNIT Inventor: Yamanaka Hideo Docket No. 075834.00466

Robert J. Depke, Holland & Knight LLC - (312) 263-3600

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# MANUFACTURING PROCESS FOR ULTRA SLIM ELECTROOPTIC DISPLAY DEVICE UNIT Inventor: Yamanaka Hideo

## Inventor: Yamanaka Hideo Docket No. 075834.00466

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# F I G. 48A

KINDS OF ELECTROOPTIC DISPLAYS	METHOD OF LAMINATION WITH FACING SUBSTRATE	GROOVE	METHOD OF BONDING WITH A SUPPORT	CUT SECTION
REFLECTIVE LCD	FACE-TO-FACE ASSEMBLY	NONE	FACE-TO-FACE ASSEMBLY OF SUPPORT	FACING/SUPPORT
	<b>←</b>	<b>←</b>	SINGLE FACE ASSEMBLY OF	FACING
			SUPPORT CHIPS	SUBSTRATE LAYER
	SINGLE FACE ASSEMBLY	<b></b>	FACE-TO-FACE ASSEMBLY OF SUPPORT	SUPPORT
	<b>←</b>	<b></b>	SINGLE FACE ASSEMBLY OF SUPPORT CHIPS	TFT SUBSTRATE LAYER
	FACE-TO-FACE ASSEMBLY	YES	FACE-TO-FACE ASSEMBLY OF SUPPORT	FACING/SUPPORT
	<b>←</b>	<b>←</b>	SINGLE FACE ASSEMBLY OF SUPPORT CHIPS	FACING SUBSTRATE
	SINGLE FACE ASSEMBLY	<b>←</b>	FACE-TO-FACE ASSEMBLY OF SUPPORT	SUPPORT
	·	↓	SINGLE FACE ASSEMBLY OF SUPPORT CHIPS	ı
UPPER FACE EMISSION TYPE ORGANIC EL	-	N O N E	FACE-TO-FACE ASSEMBLY OF SUPPORT	ORGANIC EL/SUPPORT SUBSTRATE
	1	←	SINGLE FACE ASSEMBLY OF SUPPORT CHIPS	ORGANIC EL SUBSTRATE LAYER
	l	YES	FACE-TO-FACE ASSEMBLY OF SUPPORT	ORGANIC EL/SUPPORT SUBSTRATE
	l	<b></b>	SINGLE FACE ASSEMBLY OF SUPPORT CHIPS	ORGANIC EL SUBSTRATE LAYER
TRANSMISSIVE/	FACE-TO-FACE ASSEMBLY	NONE	FACE-TO-FACE ASSEMBLY OF TRANSPARENT SUPPORT	FACING/TRANSPARENT SUPPORT

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FACING SUBSTRATE/TFT SUBSTRATE LAYER	TRANSPARENT SUPPORT	TFT SUBSTRATE LAYER	FACING/TRANSPARENT SUPPORT	FACING	SUBSTRATE	TRANSPARENT	1 10 0		ORGANIC	EL/TRANSPARENT	SUBSTRATE	ORGANIC EL	SUBSTRATE LAYER	ORGANIC	EL/TRANSPARENT	SUPPORT	ORGANIC EL	SUBSTRATE LAYER
SINGLE FACE ASSEMBLY OF TRANSPARENT SUPPORT CHIPS	FACE-TO-FACE ASSEMBLY OF TRANSPARENT SUPPORT	SINGLE FACE ASSEMBLY OF TRANSPARENT SUPPORT CHIPS	FACE-TO-FACE ASSEMBLY OF TRANSPARENT SUPPORT	1.0	TRANSPARENT SUPPORT CHIPS	FACE-TO-FACE ASSEMBLY OF	TACTIC THERE OF THE COLUMN OF	$\sim$	FACE-TO-FACE ASSEMBLY OF	TRANSPARENT SUPPORT		SINGLE FACE ASSEMBLY OF	TRANSPARENT SUPPORT CHIPS	FACE-TO-FACE ASSEMBLY OF	TRANSPARENT SUPPORT		SINGLE FACE ASSEMBLY OF	_
<b>←</b>	<b>←</b>	←-	YES	<b>←</b> -		<b>←</b>	<b>←</b>	-	NONE			<b>←</b>		YES			<b>←</b>	
<b>←</b>	SINGLE FACE ASSEMBLY	←	FACE-TO-FACE ASSEMBLY	<b>+</b>		SINGLE FACE	1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	-		I			1			l		İ
SEMI- TRANSMISSIVE LCD									LOWER FACE	EMISSION TYPE	UKGANIC EL							

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# F I G. 49A

N 0		PORT		TFT	AYER		ATF	:		PORT	PORT	PORT	PORT	PORT	PORT	PORT.	P O R T	PORT E	PORT E	PORT FE EL	C C C C C C C C C C C C C C C C C C C	PORT E RT RT EL EL	PORT RT RT EL EL AYER	PORT RT RT EL AYER RT	PORT REL EL AYER RT FE	C C C C C C C C C C C C C C C C C C C
CUT SECTION		FACING/SUPPORT	FACING	SUBSTRATE/TFT	SUBSTRATE LAYER	SUPPORT	TET CHRCTRAT		=======================================	FACING/SUPPORT	FACING/SUP	FACING/SUP FACING	FACING/SUPP FACING SUBSTRAT	FACING/SUPI FACING SUBSTRAT SUPPORT	FACING/SUP FACING SUBSTRA SUPPOR	FACING/SUP FACING SUBSTRAT SUPPORT	FACING/SUPI FACING SUBSTRAT SUPPORT -	FACING/SUPPO FACING SUBSTRATE SUPPORT - - ORGANIC EL/SUPPORT	FACING/SUPPO FACING SUBSTRATE SUPPORT - ORGANIC EL/SUPPORT SUBSTRATE	FACING/SUP FACING SUBSTRAT SUPPORT  ORGANIC SUBSTRAT ORGANIC	FACING/SUP FACING SUBSTRAT SUPPORT  ORGANIC SUBSTRAT ORGANIC					
METHOD OF BONDING WITH A	SUPPORT	FACE-TO-FACE ASSEMBLY OF SUPPORT	SINGLE FACE ASSEMBLY OF	SUPPORT CHIPS		FACE-TO-FACE ASSEMBLY OF	O A LACE BACE ASSEMBLY OF	UPPORT CHIPS	ı	FACE-TO-FACE ASSEMBLY OF			-													
GROOVE M		NONE	<b>←</b>			<b>←</b>	<b>+</b>			7 EV																
METHOD OF	LAMINATION WITH A FACING SUBSTRATE	FACE-TO-FACE ASSEMBLY	<b>←</b>			SINGLE FACE	<b>→</b>			FACE-TO-FACE	FACE-TO-FACE ASSEMBLY	FACE-TO-FACE ASSEMBLY	FACE-TO-FACE ASSEMBLY A	FACE-TO-FACE ASSEMBLY    T  SINGLE FACE ASSEMBLY	FACE-TO-FACE ASSEMBLY    SINGLE FACE ASSEMBLY	FACE-TO-FACE ASSEMBLY    SINGLE FACE ASSEMBLY   ASSEMBLY	FACE-TO-FACE ASSEMBLY   T  SINGLE FACE ASSEMBLY  ASSEMBLY	FACE-TO-FACE ASSEMBLY   T  SINGLE FACE ASSEMBLY	FACE-TO-FACE ASSEMBLY  T SINGLE FACE ASSEMBLY	FACE-TO-FACE ASSEMBLY  \$\frac{1}{A}\$ SINGLE FACE ASSEMBLY	FACE-TO-FACE ASSEMBLY  SINGLE FACE ASSEMBLY	FACE-TO-FACE ASSEMBLY  SINGLE FACE ASSEMBLY	FACE-TO-FACE ASSEMBLY  SINGLE FACE ASSEMBLY	FACE TO - FACE ASSEMBLY  SINGLE FACE ASSEMBLY	FACE TO FACE ASSEMBLY  SINGLE FACE ASSEMBLY	FACE-TO-FACE ASSEMBLY  SINGLE FACE ASSEMBLY
1	ELECTROOPTIC DISPLAYS	EFLECTIVE LCD															FACE	FACE	UPPER FACE EMISSION TYPE ORGANIC EL	FACE ON TYPE IC EL	FACE ON TYPE IC EL	FACE ON TYPE IC EL	FACE ON TYPE 1C EL	FACE ON TYPE IC EL	FACE ON TYPE IC EL	FACE ON TYPE

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FACING	T R A N S P A R E N T S U P P O R T	TFT SUBSTRATE LAYER	FACING/TRANSPARENT SUPPORT	FACING	TRANSPARENT SUPPORT	ı	ORGANIC EL/TRANSPARENT SUPPORT SUBSTRATE	ORGANIC EL SUBSTRATE LAYER	ORGANIC EL/TRANSPARENT SUPPORT SUBSTRATE	ORGANIC EL SUBSTRATE LAYER
SINGLE FACE ASSEMBLY OF TRANSPARENT SUPPORT CHIPS	FACE-TO-FACE ASSEMBLY OF TRANSPARENT SUPPORT	SINGLE FACE ASSEMBLY OF TRANSPARENT SUPPORT	FACE-TO-FACE ASSEMBLY OF TRANSPARENT SUPPORT	SINGLE FACE ASSEMBLY OF TRANSPARENT SUPPORT CHIPS	FACE-TO-FACE ASSEMBLY OF TRANSPARENT SUPPORT	SINGLE FACE ASSEMBLY OF TRANSPARENT SUPPORT CHIPS	FACE-TO-FACE ASSEMBLY OF TRANSPARENT SUPPORT	SINGLE FACE ASSEMBLY OF TRANSPARENT SUPPORT CHIPS	FACE-TO-FACE ASSEMBLY OF TRANSPARENT SUPPORT	SINGLE FACE ASSEMBLY OF TRANSPARENT SUPPORT CHIPS
<b>←</b>	<b>←</b>	<b>←</b>	YES	<b>←</b>	<b>←</b>	<b>←</b>	NONE	<b>←</b>	YES	←
<b>L</b>	SINGLE FACE ASSEMBLY	<b>.</b>	FACE-TO-FACE ASSEMBLY	1	SINGLE FACE ASSEMBLY	<b>+</b>	I	I	I	
SEMI- TRANSMISSIVE LCD							LOWER FACE EMISSION TYPE ORGANIC EL			

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# FIG. 50A

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CUT SECTION	FACING/SUPPORT		SUPPORT	TFT SUBSTRATE LAYER	FACING/SUPPORT	FACING SUBSTRATE	SUPPORT	1	ORGANIC EL/SUPPORT SUBSTRATE	ORGANIC EL SUBSTRATE LAYER	ORGANIC EL/SUPPORT SUBSTRATE	ORGANIC EL SUBSTRATE LAYER	FACING/TRANSPARENT SUPPORT
METHOD OF BONDING WITH A SUPPORT	FACE-TO-FACE ASSEMBLY OF SUPPORT	SINGLE FACE ASSEMBLY OF SUPPORT CHIPS	FACE-TO-FACE ASSEMBLY OF SUPPORT	SINGLE FACE ASSEMBLY OF SUPPORT CHIPS	FACE-TO-FACE ASSEMBLY OF SUPPORT	SINGLE FACE ASSEMBLY OF SUPPORT CHIPS	FACE-TO-FACE ASSEMBLY OF SUPPORT	SINGLE FACE ASSEMBLY OF SUPPORT CHIPS	FACE-TO-FACE ASSEMBLY OF SUPPORT	SINGLE FACE ASSEMBLY OF SUPPORT CHIPS	FACE-TO-FACE ASSEMBLY OF SUPPORT	SINGLE FACE ASSEMBLY OF SUPPORT CHIPS	FACE-TO-FACE ASSEMBLY OF TRANSPARENT SUPPORT
GROOVE	NONE	<b>←</b>	<b>←</b>	<b>←</b>	YES	<b>←</b>	<del>(</del>	<b>←</b>	NONE	<u></u>	YES	<b>←</b>	N O N E
METHOD OF LAMINATION WITH A FACING SUBSTRATE	FACE-TO-FACE ASSEMBLY	<b>←</b>	SINGLE FACE ASSEMBLY	<b>←</b>	FACE-TO-FACE ASSEMBLY	<b>←</b>	SINGLE FACE ASSEMBLY	←		l	I	l	FACE-TO-FACE ASSEMBLY
KINDS OF ELECTROOPTIC DISPLAYS	REFLECTIVE LCD								UPPER FACE EMISSION TYPE ORGANIC EL				TRANSMISSIVE/

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FACING SUBSTRATE/TFT SUBSTRATE LAYER	TRANSPARENT SUPPORT	TFT SUBSTRATE LAYER	FACING/TRANSPAR ENT SUPPORT	FACING SUBSTRATE	TRANSPARENT SUPPORT	I	ORGANIC EL/TRANSPARENT SUPPORT SUBSTRATE	ORGANIC EL SUBSTRATE LAYER	ORGANIC EL/TRANSPARENT SUPPORT SUBSTRATE	ORCANIC EL SUBSTRATE LAYER
SINGLE FACE ASSEMBLY OF TRANSPARENT SUPPORT CHIPS	FACE-TO-FACE ASSEMBLY OF TRANSPARENT SUPPORT	SINGLE FACE ASSEMBLY OF TRANSPARENT SUPPORT CHIPS	FACE-TO-FACE ASSEMBLY OF TRANSPARENT SUPPORT	SINGLE FACE ASSEMBLY OF TRANSPARENT SUPPORT CHIPS	FACE-TO-FACE ASSEMBLY OF TRANSPARENT SUPPORT	SINGLE FACE ASSEMBLY OF TRANSPARENT SUPPORT CHIPS	FACE-TO-FACE ASSEMBLY OF TRANSPARENT SUPPORT	SINGLE FACE ASSEMBLY OF TRANSPARENT SUPPORT CHIPS	FACE-TO-FACE ASSEMBLY OF TRANSPARENT SUPPORT	SINGLE FACE ASSEMBLY OF TRANSPARENT SUPPORT CHIPS
<b>←</b>	<b>←</b>	<b>←</b>	YES	←	<b>←</b>	<b>←</b>	NONE	<b>←</b>	YES	<b>-</b>
<b>←</b>	SINGLE FACE ASSEMBLY	←	FACE-TO-FACE ASSEMBLY	<b>←</b>	SINGLE FACE ASSEMBLY	←	l		l	l
SEMI- TRANSMISSIVE LCD							LOWER FACE EMISSION TYPE ORGANIC EL			

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CUT SECTION	FACING/SUPPORT	FACING	SUBSTRATE/TFT	SUPPORT		TFT SUBSTRATE	LAYEK	FACING/SUPPORT		FACING	SUBSTRATE	SUPPORT		ı	ORGANIC	EL/SUPPORT	SUBSTRATE	ORGANIC EL	SUBSTRATE LAYER	ORGANIC	EL/SUPPORT	SUBSTRATE	ORGANIC EL	SUBSTRATE LAYER	FACING/TRANSPARENT	SUPPORT
METHOD OF BONDING WITH A SUPPORT	FACE-TO-FACE ASSEMBLY OF SUPPORT	SINGLE FACE ASSEMBLY OF	SUPPORT CHIPS	FACE-TO-FACE ASSEMBLY OF	SUPPORT		SUPPUKI CHIPS	FACE-TO-FACE ASSEMBLY OF	SUPPORT	SINGTE FACE ASSEMBLY OF	SUPPORT CHIPS	FACE-TO-FACE ASSEMBLY OF	SUPPORT	SINGLE FACE ASSEMBLY OF SUPPORT CHIPS	FACE-TO-FACE ASSEMBLY OF	SUPPORT		SINGTE FACE ASSEMBLY OF	SUPPORT CHIPS	FACE-TO-FACE ASSEMBLY OF	SUPPORT		SINGLE FACE ASSEMBLY OF	SUPPORT CHIPS	FACE-TO-FACE ASSEMBLY OF	TRANSPARENT SUPPORT
GROOVE	NONE	<b>←</b>		<b>←</b>		<b>—</b>		YES		<b>←</b>		<b>←</b>		<b>←</b>	NONE			<b>←</b>		YES			<b>←</b>		NONE	
METHOD OF LAMINATION WITH A FACING SUBSTRATE	FACE-TO-FACE ASSEMBLY	<b>←</b>		SINGLE FACE	ASSEMBLY	<b>←</b>		FACE-TO-FACE	ASSEMBLY	←-		SINGLE FACE	ASSEMBLY	<b>-</b> -		ı			-		·			ı	FACE-TO-FACE	ASSEMBLY
KINDS OF ELECTROOPTIC DISPLAYS	REFLECTIVE LCD														UPPER FACE	EMISSION TYPE	ORGANIC EL								TRANSMISSIVE/	

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FACING	SUBSTRATE/TFT	SUBSTRATE LAYER	TRANSPARENT	SUPPORT	TFT SUBSTRATE	LAYER		FACING/TRANSPARENT	SUPPORT	FACING	SUBSTRATE		TRANSPARENT	SUPPORT	_			ORGANIC	EL/TRANSPARENT	SUPPORT	SUBSTRATE	ORGANIC EL	SUBSTRATE LAYER		ORGANIC	EL/TRANSPARENT	SUPPORT	SUBSTRATE
SINGLE FACE ASSEMBLY OF	TRANSPARENT SUPPORT	PS	FACE-TO-FACE ASSEMBLY OF	TRANSPARENT SUPPORT	SINCLE FACE ASSEMBLY OF	TRANSPARENT SUPPORT	CHIPS	FACE-TO-FACE ASSEMBLY OF	TRANSPARENT SUPPORT	SINCLE FACE ASSEMBLY OF	TRANSPARENT SUPPORT	CHIPS	FACE-TO-FACE ASSEMBLY OF	TRANSPARENT SUPPORT	SINGLE FACE ASSEMBLY OF	TRANSPARENT SUPPORT	CHIPS	FACE-TO-FACE ASSEMBLY OF	TRANSPARENT SUPPORT		•	SINGLE FACE ASSEMBLY OF	TRANSPARENT SUPPORT	CHIPS	FACE-TO-FACE ASSEMBLY OF	TRANSPARENT SUPPORT		
<b>←</b>			<del>(-</del>		<b>↓</b>			YES		<b>\</b>			<b>←</b>		↓			NONE				<b>←</b>			YES	-		
<b>+</b>	,	- 1	SINGLE FACE	ASSEMBLY	<b>←</b>			FACE-TO-FACE	ASSEMBLY	Ļ			SINGLE FACE	ASSEMBLY	<b>.</b>				1				ı				· 	
SEMI-	TRANSMISSIVE	LCD																LOWER FACE	EMISSION TYPE	ORGANIC EL								

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CUT SECTION	FACING/SUPPORT	FACING	SUBSTRATE/TFT	SUBSTRATE LAYER	SUPPORT	TFT SUBSTRATE	LAYER	FACING/SUPPORT	FACING	SUBSTRATE/TFT	SUBSTRATE LAYER	SUPPORT		ı	ORGANIC	EL/SUPPORT	SUBSTRATE	ORGANIC EL	SUBSTRATE LAYER	ORGANIC	EL/SUPPORT	SUBSTRATE	ORGANIC EL	SUBSTRATE LAYER	FACING/TRANSPAR	ENT SUPPORT
METHOD OF BONDING WITH A SUPPORT	FACE-TO-FACE ASSEMBLY OF SUPPORT	SINGLE FACE ASSEMBLY OF	SUPPORT CHIPS		FACE-TO-FACE ASSEMBLY OF SUPPORT	SINGLE FACE ASSEMBLY OF	SUPPORT CHIPS	FACE-TO-FACE ASSEMBLY OF SUPPORT	SINGLE FACE ASSEMBLY OF	SUPPORT CHIPS		FACE-TO-FACE ASSEMBLY OF	3 U P F	SINGLE FACE ASSEMBLY OF SUPPORT CHIPS		SUPPORT		SINGLE FACE ASSEMBLY OF	SUPPORT CHIPS	FACE-TO-FACE ASSEMBLY OF	SUPPORT		SINGLE FACE ASSEMBLY OF	SUPPORT CHIPS	FACE-TO-FACE ASSEMBLY OF	TRANSPARENT SUPPORT
GROOVE	N O N E	<b>←</b>			<b>←</b>	↓		YES	<b>—</b>			J		<del>(-</del>	NONE			Ų.		YES			<b>←</b>		N O N E	
METHOD OF LAMINATION WITH A FACING SUBSTRATE	FACE-TO-FACE ASSEMBLY	4			SINGLE FACE ASSEMBLY	<b>+</b>		FACE-TO-FACE ASSEMBLY	<b>←</b>			SINGLE FACE	ASSEMBLI	←	10 Marie 10	1		I			ı	THE PROPERTY AND ADDRESS OF THE PROPERTY ADDRESS OF THE PROPERTY AND ADDRESS OF THE PROPERTY ADDRESS OF TH	1		- FACE-TO-FACE	ASSEMBLY
KINDS OF ELECTROOPTIC DISPLAYS	REFLECTIVE LCD														UPPER FACE	ENISSION TYPE	ORGANIC EL								TRANSMISSIVE/	

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FACING SUBSTRATE/TFT SUBSTRATE LAYER	TRANSPARENT SUPPORT	TFT SUBSTRATE	LAYER	FACING/TRANSPARENT SUPPORT	FACING		SUBSIKAIE LAYEK	TRANSPARENT	1001100			ORGANIC	EL/TRANSPARENT	SUPPORT	SUBSTRATE	ORGANIC EL	SUBSTRATE LAYER		ORGANIC	EL/TRANSPARENT	SUPPORT	SUBSTRATE	ORGANIC EL	SUBSTRATE LAYER	
SINGLE FACE ASSEMBLY OF TRANSPARENT SUPPORT CHIPS	FACE-TO-FACE ASSEMBLY OF TRANSPARENT SUPPORT	SINGLE FACE ASSEMBLY OF	TRANSPARENT SUPPORT CHIPS	FACE-TO-FACE ASSEMBLY OF TRANSPARENT SUPPORT	SINGLE FACE ASSEMBLY OF	TRANSPARENT SUPPORT	CHIPS	FACE-TO-FACE ASSEMBLY OF	CINCIE EACE ACCEUDIA OF	FACE ASSEMBLI	TRANSPARENT SUPPORT CHIPS	FACE-TO-FACE ASSEMBLY OF	TRANSPARENT SUPPORT			SINGLE FACE ASSEMBLY OF	TRANSPARENT SUPPORT	P S	FACE-TO-FACE ASSEMBLY OF	TRANSPARENT SUPPORT			SINGLE FACE ASSEMBLY OF	TRANSPARENT SUPPORT	CHIPS
<b>←</b>	<b>←</b>	<b>←</b>		YES	<b>←</b>			←	+	_		NONE				<b>←</b>			YES				. ↓		
<b>.</b>	SINGLE FACE ASSEMBLY	<b>←</b>		FACE-TO-FACE ASSEMBLY	<b>←</b>	·		SINGLE FACE	A 3 3 L M 2 L 1	-				1			1				ı			1	
SEMI- TRANSMISSIVE LCD												LOWER FACE	EMISSION TYPE	ORGANIC EL											